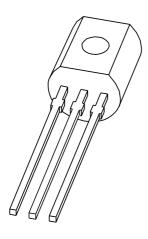
DISCRETE SEMICONDUCTORS

DATA SHEET



PN2369A NPN switching transistor

Product specification Supersedes data of 1999 Apr 14

2004 Dec 08





NPN switching transistor

PN2369A

FEATURES

- Low current (max. 200 mA)
- Low voltage (max. 15 V).

APPLICATIONS

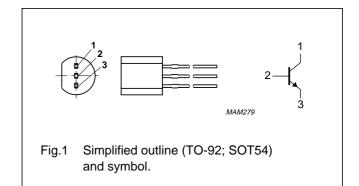
· High-speed switching applications.

DESCRIPTION

NPN switching transistor in a TO-92; SOT54 plastic package.

PINNING

PIN	DESCRIPTION
1	collector
2	base
3	emitter



ORDERING INFORMATION

TYPE NUMBER		PACKAGE					
TTPE NOWIBER	NAME DESCRIPTION						
PN2369A	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54				

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	40	V
V _{CEO}	collector-emitter voltage	open base	_	15	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	collector current (DC)		_	200	mA
I _{CM}	peak collector current		_	300	mA
I _{BM}	peak base current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	250	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

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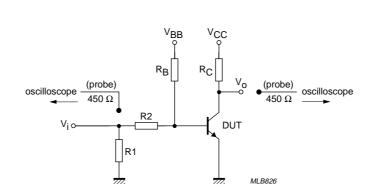
CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 20 V; I _E = 0 A	_	_	400	nA
		V _{CB} = 20 V; I _E = 0 A; T _{amb} = 125 °C	_	_	30	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 4 V; I _C = 0 A	_	_	100	nA
h _{FE}	DC current gain	$V_{CE} = 350 \text{ mV}; I_{C} = 10 \text{ mA}$	40	_	120	
		$V_{CE} = 350 \text{ mV}; I_C = 10 \text{ mA};$ $T_{amb} = -55 \text{ °C}$	20	_	_	
		V _{CE} = 400 mV; I _C = 30 mA	30	_	_	
		V _{CE} = 1 V; I _C = 100 mA	20	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 10 mA; I _B = 1 mA	_	_	200	mV
		I _C = 10 mA; I _B = 10 mA	_	_	300	mV
		$I_C = 30 \text{ mA}; I_B = 3 \text{ mA}$	_	_	250	mV
		I _C = 100 mA; I _B = 10 mA	_	_	500	mV
V _{BEsat}	base-emitter saturation voltage	I _C = 10 mA; I _B = 1 mA	700	_	850	mV
C _c	collector capacitance	$V_{CB} = 5 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	_	4	pF
f _T	transition frequency	$V_{CE} = 10 \text{ V}; I_{C} = 10 \text{ mA}; f = 100 \text{ MHz}$	500	_	_	MHz
Switching t	imes (between 10% and 90% levels	s); see Fig.2			•	
t _{on}	turn-on time	I _{Con} = 10 mA; I _{Bon} = 3 mA;	_	8	10	ns
t _d	delay time	I _{Boff} = −1.5 mA	_	_	4	ns
t _r	rise time		_	_	6	ns
t _{off}	turn-off time		_	10	20	ns
t _s	storage time		_	_	10	ns
t _f	fall time		_		10	ns

NPN switching transistor

PN2369A



 V_i = 0.5 V to 4.2 V; T = 500 $\mu s;$ t_p = 10 $\mu s;$ t_r = $t_f \leq 1$ ns.

R1 = 56 Ω ; R2 = 1 k Ω ; R_B = 1 k Ω ; R_C = 270 Ω .

 V_{BB} = 0.2 V; V_{CC} = 2.7 V.

Oscilloscope: input impedance Z_i = 50 Ω .

Fig.2 Test circuit for switching times.

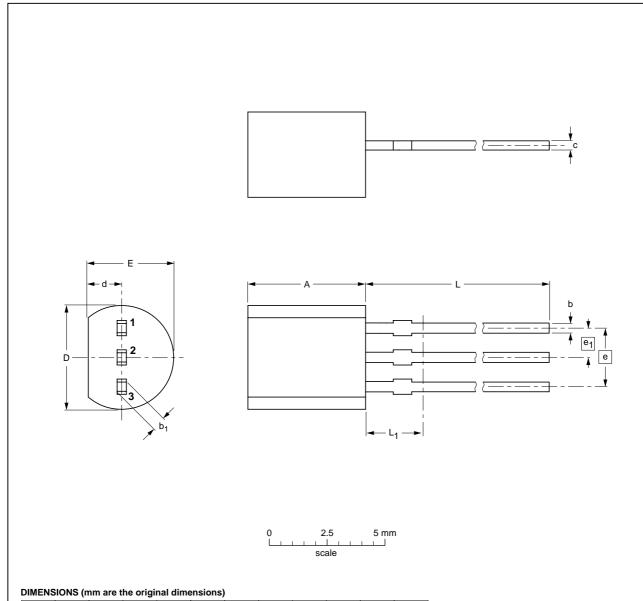
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PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT54		TO-92	SC-43A			04-06-28 04-11-16

NPN switching transistor

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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